



## Material Content Data Sheet



<b>Sales Product Name</b>				ESD242-B1-W01005 E6327		<b>Issued</b>		22. January 2018	
<b>MA#</b>				MA001632398					
<b>Package</b>				SG-WLL-2-2		<b>Weight*</b>		0.04 mg	
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	0.039	91.59	91.59	915801	915801	
pad	inorganic material	silicon	7440-21-3	0.000	0.00		23		
	non noble metal	copper	7440-50-8	0.000	0.00		47		
	inorganic material	phosphorus	7723-14-0	0.000	0.13		1328		
	noble metal	gold	7440-57-5	0.000	0.14		1397		
	non noble metal	aluminium	7429-90-5	0.000	0.53		5334		
	noble metal	palladium	7440-05-3	0.000	0.87		8711		
	non noble metal	nickel	7440-02-0	0.003	6.40	8.07	63959	80799	
passivation	inorganic material	SiO2	60676-86-0	0.000	0.11		1071		
	inorganic material	siliciumnitride	12033-89-5	0.000	0.23	0.34	2329	3400	
*deviation	< 10%		Sum in total:			100.00		1000000	

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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